

SN54159, SN74159

4-LINE TO 16-LINE DECODERS/DEMULTIPLEXERS

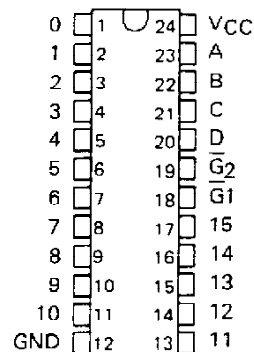
WITH OPEN-COLLECTOR OUTPUTS

DECEMBER 1972 - REVISED MARCH 1988

- Open-Collector Outputs for Interfacing with MOS or Memory Decoders/Drivers
- Decodes 4 Binary-Coded Inputs into One of 16 Mutually Exclusive Outputs
- Performs the Demultiplexing Function by Distributing Data from One Input Line to Any One of 16 Outputs
- Typical Average Propagation Delay Times:
24 ns through 3 levels of Logic
19 ns from Strobe Input
- Output Off-State Current is Less Than 50 μ A
- Fully Compatible with Most TTL and MSI Circuits

SN54159 . . . J OR W PACKAGE
SN74159 . . . N PACKAGE

(TOP VIEW)



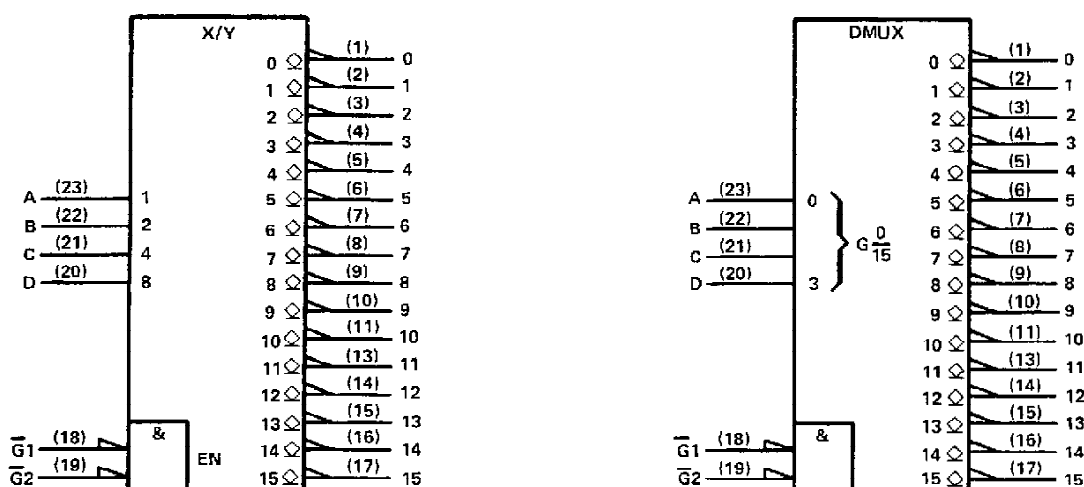
description

Each of these monolithic, 4-line-to-16 line decoders utilizes TTL circuitry to decode four binary-coded inputs into one of sixteen mutually exclusive open-collector outputs when both the strobe inputs, $\overline{G1}$ and $\overline{G2}$, are low. The demultiplexing function is performed by using the 4 input lines to address the output line, passing data from one of the strobe inputs with the other strobe input low. When either strobe input is high, all outputs are high. These demultiplexers are ideally suited for implementing MOS memory decoding or for interfacing with discrete memory address drivers. For ultra-high-speed applications, the SN54S138/SN74S138 or SN54S139/SN74S139 is recommended.

These circuits are fully compatible for use with most other TTL circuits. Input clamping diodes are provided to minimize transmission-line effects and thereby simplify system design. Input buffers are used to lower the fan-in requirement to only one normalized Series 54/74 load. A fan-out to 10 normalized Series 54/74 loads in the low-level state is available from each of the sixteen outputs. Typical power dissipation is 170 mW.

The SN54159 is characterized for operation over the full military temperature range of -55°C to 125°C ; the SN74159 is characterized for operation from 0°C to 70°C .

logic symbols (alternatives)[†]



[†]These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

PRODUCTION DATA documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

TEXAS
INSTRUMENTS

POST OFFICE BOX 655012 • DALLAS, TEXAS 75265

SN54159, SN74159
4-LINE TO 16-LINE DECODERS/DEMULTIPLEXERS
WITH OPEN-COLLECTOR OUTPUTS

FUNCTION TABLE

[illegible]

H = high level, L = low level, X = irrelevant

logic diagram

Same as SN54154, SN74154.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1)	7 V
Input voltage	5.5 V
Off-state output voltage	5.5 V
Operating free-air temperature range: SN54159 Circuits	-55°C to 125°C
SN74159 Circuits	0°C to 70°C
Storage temperature range	-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

SN54159, SN74159 **4-LINE TO 16-LINE DECODERS/DEMULTIPLEXERS** **WITH OPEN-COLLECTOR OUTPUTS**

recommended operating conditions

	SN54159			SN74159			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}	4.5	5	5.5	4.75	5	5.25	V
Low-level output current, I_{OL}			16			16	mA
Operating free-air temperature, T_A	-55		125	0		70	$^{\circ}$ C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†	MIN	TYP‡	MAX	UNIT
V_{IH} High-level input voltage		2			V
V_{IL} Low-level input voltage				0.8	V
V_{IK} Input clamp voltage	$V_{CC} = \text{MIN}$, $I_I = -12 \text{ mA}$			-1.5	V
I_{OH} High-level output current	$V_{CC} = \text{MIN}$, $V_{IH} = 2 \text{ V}$, $V_{IL} = 0.8 \text{ V}$, $V_{OH} = 5.5 \text{ V}$			50	μ A
V_{OL} Low-level output voltage	$V_{CC} = \text{MIN}$, $V_{IH} = 2 \text{ V}$, $V_{IL} = 0.8 \text{ V}$, $I_{OL} = 16 \text{ mA}$			0.4	V
I_I Input current at maximum input voltage	$V_{CC} = \text{MAX}$, $V_I = 5.5 \text{ V}$			1	mA
I_{IH} High-level input current	$V_{CC} = \text{MAX}$, $V_I = 2.4 \text{ V}$			40	μ A
I_{IL} Low-level input current	$V_{CC} = \text{MAX}$, $V_I = 0.4 \text{ V}$			-1.6	mA
I_{CC} Supply current	$V_{CC} = \text{MAX}$, All inputs grounded		34	56	mA

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

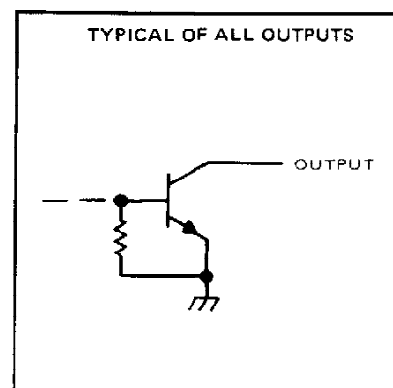
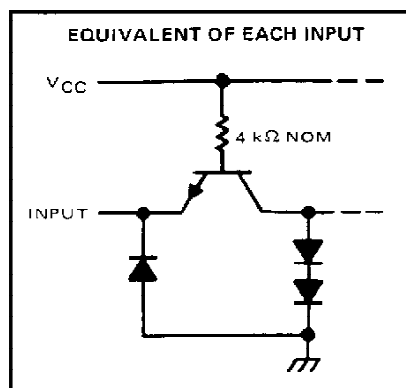
‡All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH} Propagation delay time, low-to-high-level output, from A, B, C, or D inputs through 3 levels of logic	$C_L = 15 \text{ pF}$, $R_L = 400 \Omega$, See Note 2		23	36	ns
t_{PHL} Propagation delay time, high-to-low-level output, from A, B, C, or D inputs through 3 levels of logic			24	36	ns
t_{PLH} Propagation delay time, low-to-high-level output, from either strobe input			15	25	ns
t_{PHL} Propagation delay time, high-to-low-level output, from either strobe input			22	36	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

schematics of inputs and outputs



TEXAS
INSTRUMENTS

POST OFFICE BOX 455012 • DALLAS, TEXAS 75265

IMPORTANT NOTICE

Texas Instruments (TI) reserves the right to make changes to its products or to discontinue any semiconductor product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current.

TI warrants performance of its semiconductor products and related software to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Certain applications using semiconductor products may involve potential risks of death, personal injury, or severe property or environmental damage ("Critical Applications").

TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, INTENDED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT APPLICATIONS, DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS.

Inclusion of TI products in such applications is understood to be fully at the risk of the customer. Use of TI products in such applications requires the written approval of an appropriate TI officer. Questions concerning potential risk applications should be directed to TI through a local SC sales office.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein. Nor does TI warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used.